

Product Summary

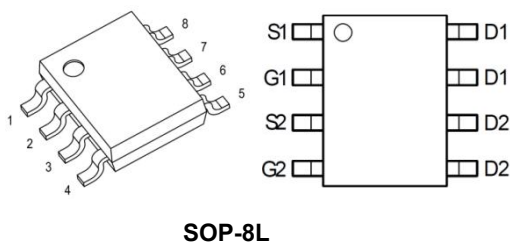
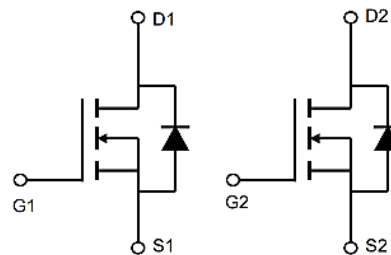
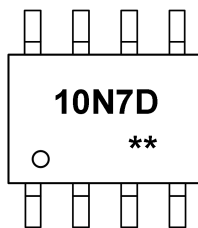
| $V_{(BR)DSS}$ | $R_{DS(on)TYP}$ | I_D |
|---------------|-----------------|-------|
| 100V | 70mΩ@10V | 7A |
| | 85mΩ@4.5V | |

Feature

- Low on-resistance
- Fast Switching

Application

- Synchronous Rectifier
- Primary Switch For Bridge Topology

Package

Circuit diagram

Marking


10N7D : Product code
 ** : Week code.

Absolute maximum ratings (Ta=25°C unless otherwise noted)

| Parameter | Symbol | Rating | Units |
|--|------------------|------------|-------|
| Drain-Source Voltage | V _{DS} | 100 | V |
| Gate-Source Voltage | V _{GS} | ±20 | V |
| Continuous Drain Current, VGS @ 10V ¹ | I _D | 7 | A |
| Pulsed Drain Current ² | I _{DM} | 28 | A |
| Total Power Dissipation | P _D | 2.5 | W |
| Thermal Resistance Junction-ambient ¹ | R _{θJA} | 50 | °C/W |
| Storage Temperature Range | T _{STG} | -55 to 150 | °C |
| Operating Junction Temperature Range | T _J | -55 to 150 | °C |

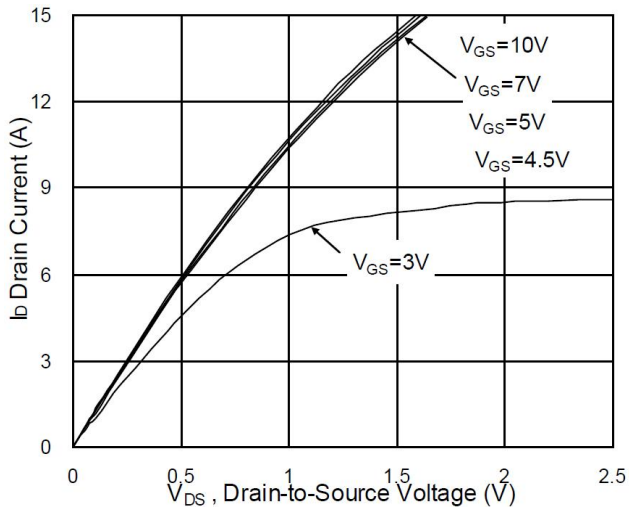
Electrical characteristics (T_A=25 °C, unless otherwise noted)

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|--|---------------------|------------------------------------|------|------|------|------|
| Static Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | VGS=0V, ID=250uA | 100 | | | V |
| Drain-Source Leakage Current | I _{DSS} | VDS=80V, VGS=0V, TJ=25°C | | | 1 | uA |
| Gate-Source Leakage Current | I _{GSS} | VGS=±20V, VDS=0V | | | ±100 | nA |
| Gate Threshold Voltage | V _{GS(th)} | VGS=VDS, ID=250uA | 1.2 | 1.8 | 2.5 | V |
| Static Drain-Source On-Resistance ² | R _{DS(on)} | VGS=10V, ID=2A | | 70 | 100 | mΩ |
| | | VGS=4.5V, ID=1A | | 85 | 110 | |
| Dynamic Characteristics | | | | | | |
| Total Gate Charge (10V) | Q _g | VDS=80V, VGS=10V, ID=2A | | 26.2 | 36.7 | nC |
| Gate-Source Charge | Q _{gs} | | | 3.8 | 5.32 | |
| Gate-Drain Charge | Q _{gd} | | | 4.8 | 6.7 | |
| Input Capacitance | C _{iss} | VDS=15V, VGS=0V, f=1MHz | | 1535 | 2149 | pF |
| Output Capacitance | C _{oss} | | | 60 | 84 | |
| Reverse Transfer Capacitance | C _{rss} | | | 37 | 52 | |
| Switching Characteristics | | | | | | |
| Turn-On Delay Time | T _{d(on)} | VDD=50V, VGS=10V, RG=3.3Ω ID=2A | | 4.2 | 8.4 | ns |
| Rise Time | T _r | | | 7.6 | 14 | |
| Turn-Off Delay Time | T _{d(off)} | | | 41 | 82 | |
| Fall Time | T _f | | | 14 | 28 | |
| Drain-Source Diode Characteristics | | | | | | |
| Continuous Source Current ^{1,4} | I _S | VG=VD=0V, Force Current | | | 2.5 | A |
| Pulsed Source Current ^{2,4} | I _{SM} | | | | 10 | A |
| Diode Forward Voltage ² | V _{SD} | VGS=0V, IS=1A, TJ=25°C | | | 1.2 | V |
| Reverse Recovery Time | t _{rr} | IF=2A, dI/dt=100A/μs, TJ=25°C | | 35 | | nS |
| Reverse Recovery Charge | Q _{rr} | | | | 17 | |

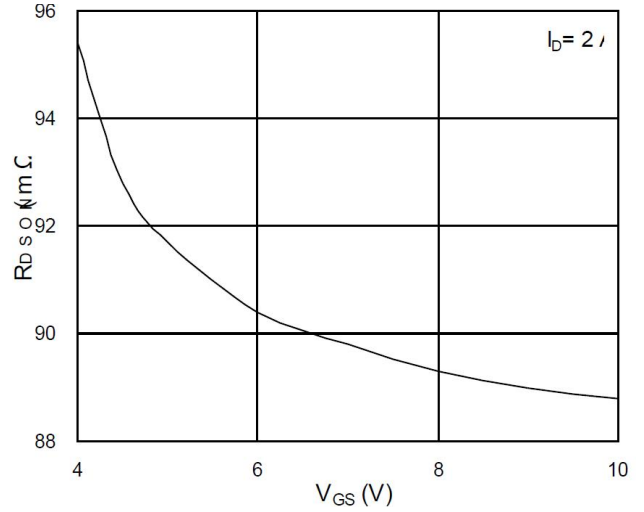
Note:

- The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- The data tested by pulsed, pulse width ≦ 300us, duty cycle ≦ 2%
- The power dissipation is limited by 150°C junction temperature
- The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.

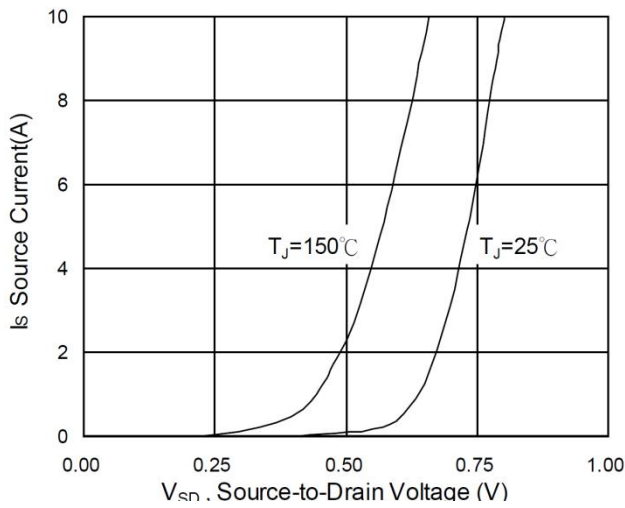
Typical Characteristics



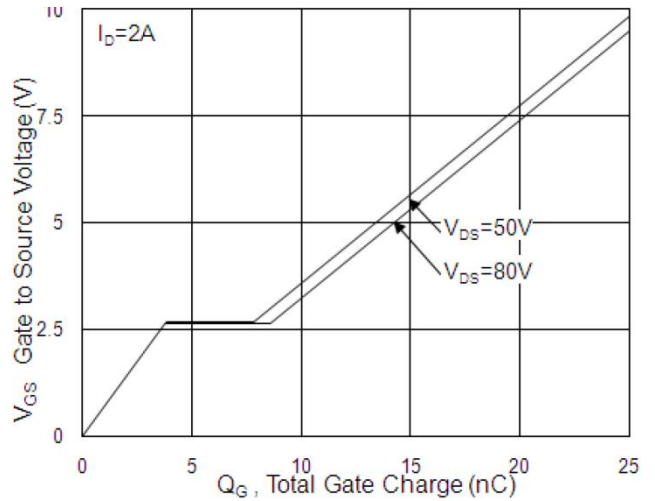
Typical Output Characteristics



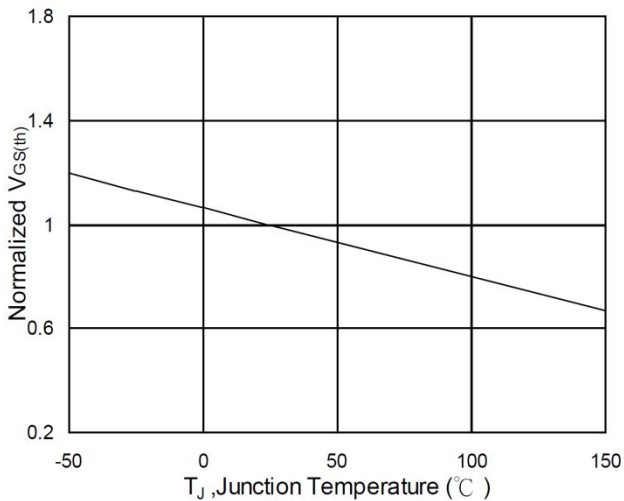
On-Resistance vs. Gate-Source



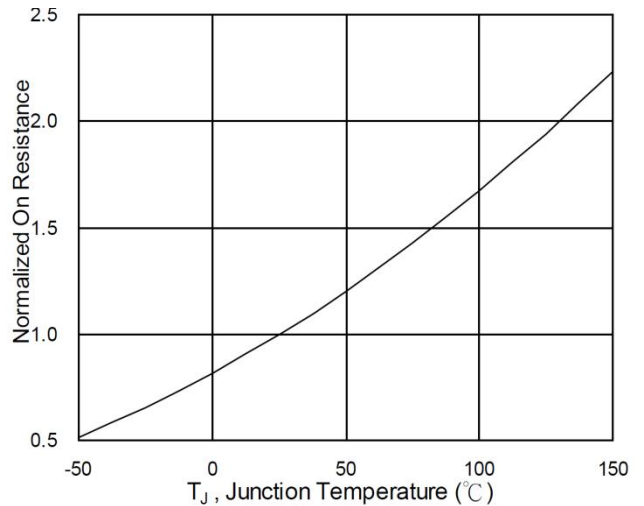
Forward Characteristics Of Reverse



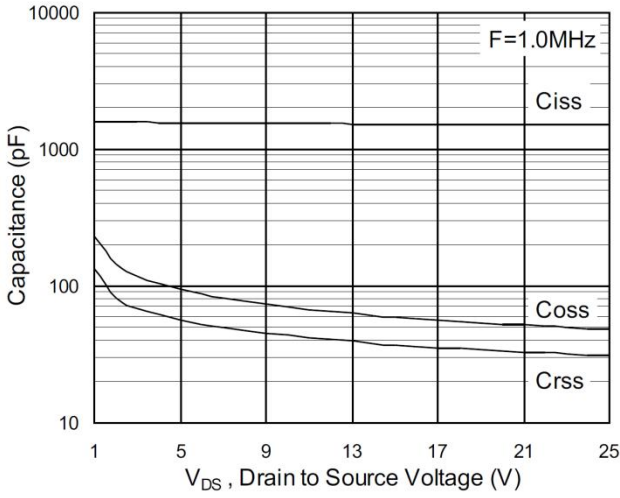
Gate-Charge Characteristics



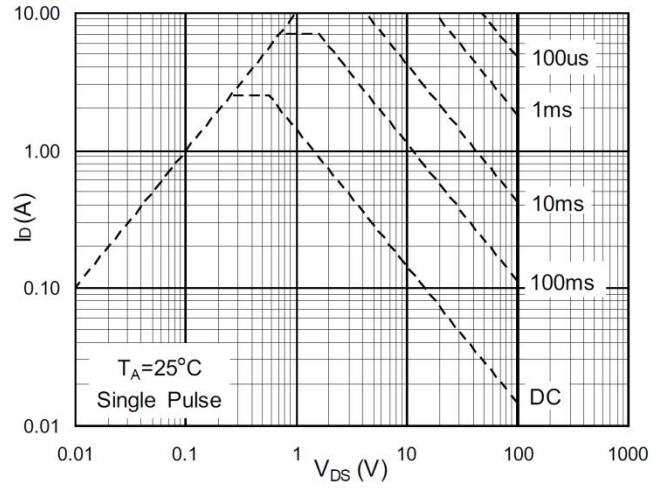
Normalized VGS(th) vs. TJ



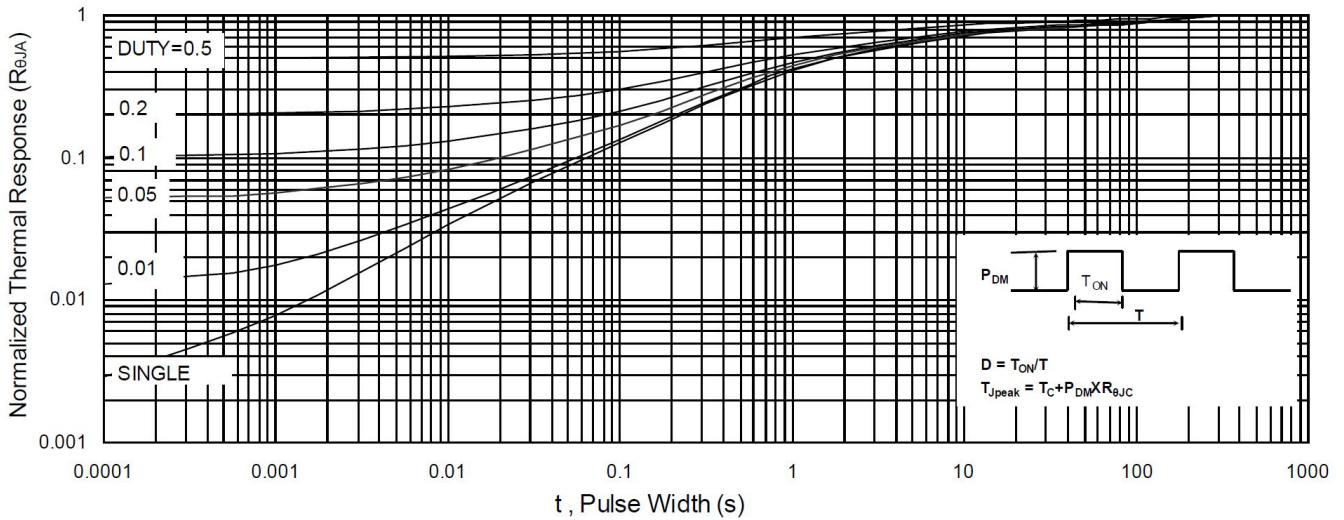
Normalized RDSON vs. TJ



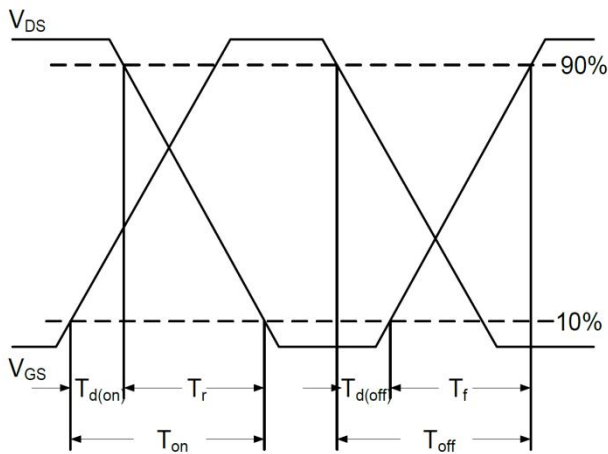
Capacitance



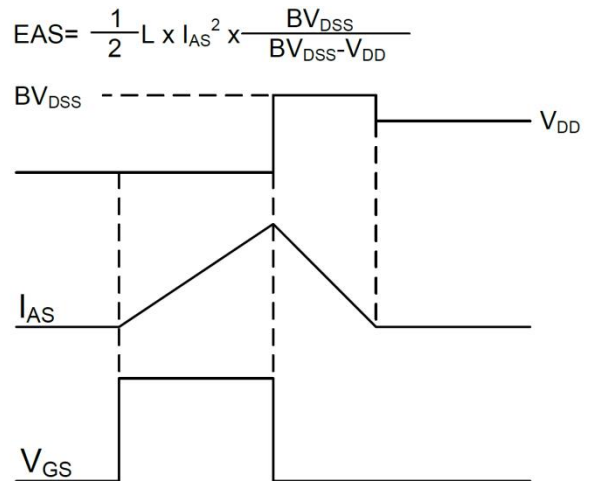
Safe Operating Area



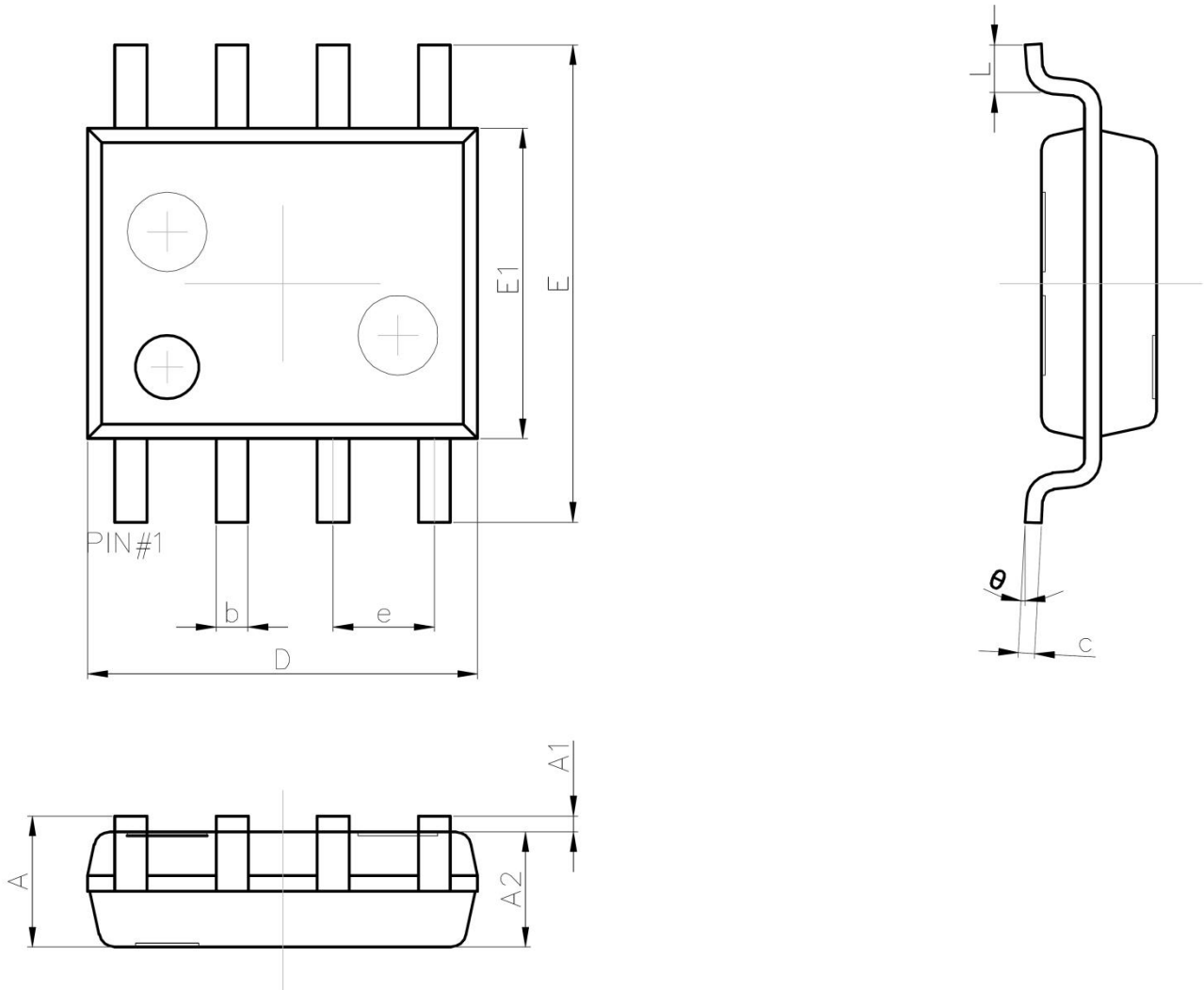
Normalized Maximum Transient Thermal Impedance



Switching Time Waveform



Unclamped Inductive Switching Waveform

SOP-8 Package Information


| Symbol | Dimensions In Millimeters | |
|----------|---------------------------|------|
| | Min. | Max. |
| A | 1.35 | 1.75 |
| A1 | 0.10 | 0.25 |
| A2 | 1.35 | 1.55 |
| b | 0.33 | 0.51 |
| c | 0.17 | 0.25 |
| D | 4.80 | 5.00 |
| e | 1.27 REF. | |
| E | 5.80 | 6.20 |
| E1 | 3.80 | 4.00 |
| L | 0.40 | 1.27 |
| θ | 0° | 8° |

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